

## 1N5415 thru 1N5420

### VOIDLESS-HERMETICALLY SEALED FAST RECOVERY GLASS RECTIFIERS

	MOUNT
DESCRIPTION	APPEARANCE
This "fast recovery" rectifier diode series is military qualified to M and is ideal for high-reliability applications where a failure cannor These industry-recognized 3.0 Amp rated rectifiers for working p voltages from 50 to 600 volts are hermetically sealed with voide construction using an internal "Category I" metallurgical bond. also available in surface mount MELF package configurations b suffix (see separate data sheet for 1N5415US thru 1N5420US). offers numerous other rectifier products to meet higher and low with various recovery time speed requirements including fast are types in both through-hole and surface mount packages.	ot be tolerated. peak reverse ess-glass These devices are by adding a "US" . Microsemi also rer current ratings nd ultrafast device <b>"E" Package</b>
<b>IMPORTANT:</b> For the most current data, consult <i>MICROSEMI's</i> website: <b>FEATURES</b>	APPLICATIONS / BENEFITS
<ul> <li>Popular JEDEC registered 1N5415 to 1N5420 series</li> <li>Voidless hermetically sealed glass package</li> <li>Triple-Layer Passivation</li> <li>Internal "<i>Category I</i>" Metallurgical bonds</li> <li>Working Peak Reverse Voltage 50 to 600 Volts.</li> <li>JAN, JANTX, JANTXV, and JANS available per MIL- PRF-19500/411</li> <li>Surface mount equivalents also available in a square end-cap MELF configuration with "US" suffix (see separate data sheet for 1N5415US thru 1N5420US)</li> </ul>	<ul> <li>Fast recovery 3 Amp rectifiers 50 to 600 V</li> <li>Military and other high-reliability applications</li> <li>General rectifier applications including bridges, half-bridges, catch diodes, etc.</li> <li>High forward surge current capability</li> <li>Extremely robust construction</li> <li>Low thermal resistance</li> <li>Controlled avalanche with peak reverse power capability</li> <li>Inherently radiation hard as described in Microsemi MicroNote 050</li> </ul>
MAXIMUM RATINGS	MECHANICAL AND PACKAGING
<ul> <li>Junction Temperature: -65°C to +175°C</li> <li>Storage Temperature: -65°C to +175°C</li> <li>Thermal Resistance: 20°C/W junction to lead at 3/8 inch (10 mm) lead length from body</li> <li>Thermal Impedance: 1.5°C/W @ 10 ms heating time</li> <li>Average Rectified Forward Current (I<sub>0</sub>): 3 Amps @ T<sub>A</sub> = 55°C and 2 Amps @ T<sub>A</sub> = 100°C (see Note 1)</li> <li>Forward Surge Current (8.3 ms half sine): 80 Amps</li> <li>Solder temperatures: 260°C for 10 s (maximum)</li> </ul>	<ul> <li>CASE: Hermetically sealed voidless hard glass with Tungsten slugs</li> <li>TERMINATIONS: Axial-leads are Tin/Lead (Sn/Pb) over Copper except for JANS with solid Silver (Ag) and no finish</li> <li>MARKING: Body paint and part number, etc.</li> <li>POLARITY: Cathode band</li> <li>TAPE &amp; REEL option: Standard per EIA-296</li> <li>WEIGHT: 750 mg</li> </ul>
	See package dimensions on last page

#### **ELECTRICAL CHARACTERISTICS**

TYPE	VRWM	MINIMUM BREAKDOWN VOLTAGE V <sub>BR</sub> @ 50µA	FORWARD VOLTAGE V <sub>F</sub> @ 9 A		AKDOWN VOLTAGE REVERSE DLTAGE V <sub>F</sub> @9A CURRENT	RSE	MAXIMUM REVERSE RECOVERY TIME t <sub>rr</sub>	AVERAGE RECTIFIED CURRENT I <sub>O</sub> (NOTE 1)	
		VOLTS	MIN. VOLTS	MAX. VOLTS	25°C μΑ	100°C μΑ	(NOTE 2) ns	55°C AMPS	100°C AMPS
1N5415	50V	55V	0.6	1.5	1.0	20	150	3.0	2.0
1N5416	100V	110V	0.6	1.5	1.0	20	150	3.0	2.0
1N5417	200V	220V	0.6	1.5	1.0	20	150	3.0	2.0
1N5418	400V	440V	0.6	1.5	1.0	20	150	3.0	2.0
1N5419	500V	550V	0.6	1.5	1.0	20	250	3.0	2.0
1N5420	600V	660V	0.6	1.5	1.0	20	400	3.0	2.0

**NOTE 1:** From 3.0 Amps at  $T_A = 55^{\circ}$ C, derate linearly at 22 mA/°C to 2.0 Amps at  $T_A = 100^{\circ}$ C. Above  $T_A = 100^{\circ}$ C, derate linearly to zero at T<sub>A</sub> = 175 °C. These ambient ratings are for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where  $T_{J(max)}$  does not exceed 175  $^{\circ}\text{C}.$ **NOTE 2:**  $I_F = 0.5A$ ,  $I_{RM} = 1A$ ,  $I_{R(REC)} = 0.250A$ 

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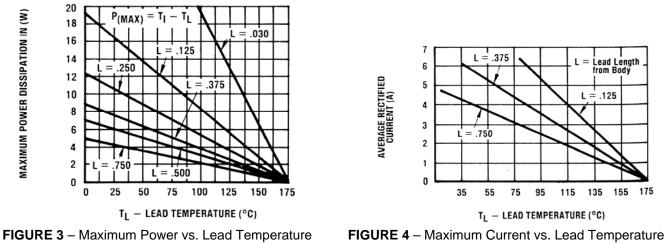
### VOIDLESS-HERMETICALLY SEALED FAST RECOVERY GLASS RECTIFIERS

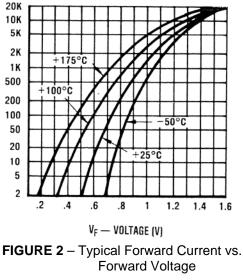
Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current. Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating emperature range excluding all transient voltages (ref JESD282-B).
emperature range excluding all transient voltages (ref JESD282-B).
Average Rectified Output Current: The Output Current averaged over a full cycle with a 50 Hz or 60 Hz sin wave input and a 180 degree conduction angle.
Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.
Maximum Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage a emperature.
Reverse Recovery Time: The time interval between the instant the current passes through zero when changing from the forward direction to the reverse direction and a specified decay point after a peak revers current occurs.

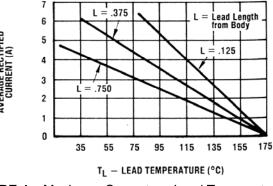
I<sub>F</sub> — CURRENT (mA)

.000 .0002 .0005 .001 50°C .002 .005 .01 .02 IF - CURRENT (µA) .05 .1 .2 .5 1 2 100°C 5 10 20 150°C 50 100 200 500 1000 150 100 50 % PIV

FIGURE 1 - Typical Reverse Current vs. PIV





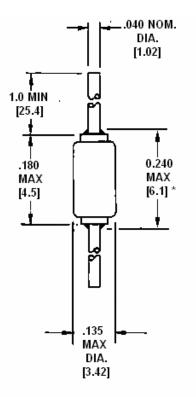


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#### DIMENSIONS AND SCHEMATIC



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Authorized Distributor

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